

Frequency Mixer

RMS-ED6629/1

Level 7 (LO Power +7 dBm)

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

CASE STYLE : TT240

ELECTRICAL SPECIFICATIONS 50Ω @ +25°C					
Parameter		Min.	Typ.	Max.	Units
Frequency	LO (f _L to f _U)	750		2450	MHz
	RF (f _L to f _U)	750		2450	MHz
	IF	0.3		570	MHz
Conversion Loss			5.7		dB
LO-RF Isolation			37		dB
LO-IF Isolation			31		dB

MAXIMUM RATINGS	
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C

PIN CONNECTIONS	
LO	1
RF	4
IF	5
GROUND	2, 3, 6

Typical Performance Data

RF (MHz)	LO (MHz)	CONVERSION LOSS (dB)			LO (MHz)	LO-RF ISOLATION (dB)			LO-IF ISOLATION (dB)		
		@LO (dBm)				@LO (dBm)			@LO (dBm)		
		+4	+7	+10		+4	+7	+10	+4	+7	+10
750.0	720.0	7.64	7.14	7.04	720.0	24.7	26.2	27.7	11.6	13.3	14.8
850.0	820.0	6.44	6.04	5.84	820.0	27.3	29.0	30.1	14.0	15.6	17.0
950.0	920.0	5.66	5.36	5.26	920.0	32.0	33.1	33.8	16.8	18.3	19.5
1050.0	1020.0	5.20	4.90	4.80	1020.0	38.2	40.4	40.0	19.0	20.5	21.6
1150.0	1120.0	5.11	4.81	4.61	1120.0	41.5	41.8	40.7	21.6	23.0	24.0
1250.0	1220.0	5.18	4.98	4.78	1220.0	37.9	38.0	39.1	24.4	25.9	26.7
1350.0	1320.0	5.51	5.31	5.11	1320.0	39.1	37.8	38.6	26.7	28.1	28.9
1450.0	1420.0	5.83	5.63	5.53	1420.0	40.7	40.0	40.2	29.0	30.2	30.8
1550.0	1520.0	5.53	5.53	5.53	1520.0	37.7	37.5	38.2	30.1	31.1	31.7
1650.0	1620.0	5.28	5.18	5.18	1620.0	44.0	42.8	42.8	30.9	32.3	33.2
1750.0	1720.0	5.25	5.05	5.05	1720.0	42.7	44.0	44.4	31.2	33.3	34.3
1830.0	1800.0	5.36	5.26	5.26	1800.0	38.8	41.0	42.0	31.3	33.5	34.6
1850.0	1820.0	5.40	5.30	5.30	1820.0	38.3	40.0	41.2	31.5	33.6	34.7
1950.0	1920.0	5.89	5.69	5.59	1920.0	37.4	38.1	38.5	32.9	35.1	35.9
2050.0	2020.0	5.91	5.71	5.51	2020.0	35.7	36.5	36.7	34.3	36.5	37.2
2150.0	2120.0	6.16	5.96	5.86	2120.0	33.2	34.2	34.6	35.4	37.7	38.3
2200.0	2170.0	6.31	6.11	6.01	2170.0	32.4	33.5	34.0	36.1	38.0	38.4
2250.0	2220.0	6.49	6.29	6.29	2220.0	31.4	32.8	33.6	36.3	38.6	38.9
2350.0	2320.0	6.77	6.27	6.07	2320.0	30.9	31.6	32.1	38.6	42.0	41.1
2450.0	2420.0	7.03	6.93	6.83	2420.0	31.8	32.9	33.2	42.8	45.4	42.6

Frequency Mixer

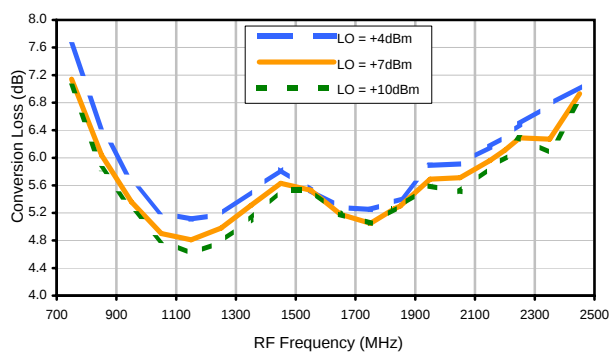
RMS-ED6629/1

Typical Performance Data

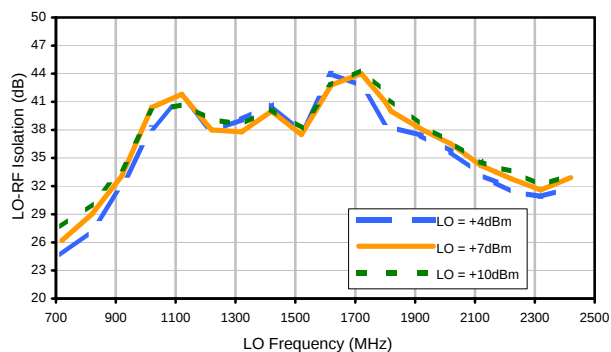
RF/LO (MHz)	RF VSWR (:1)			LO VSWR (:1)			IF (MHz)	IF VSWR (:1)		
	@LO (dBm)			@LO (dBm)				@LO (dBm)		
	+4	+7	+10	+4	+7	+10		+4	+7	+10
720.0	2.06	1.69	1.91	4.22	4.22	4.22	0.3	1.26	1.16	1.11
820.0	1.82	1.66	1.97	3.01	2.96	2.92	0.5	1.29	1.19	1.13
920.0	1.66	1.67	2.12	2.27	2.20	2.10	0.8	1.31	1.21	1.15
1020.0	1.58	1.71	2.32	1.56	1.49	1.44	1.0	1.32	1.21	1.16
1120.0	1.44	1.74	2.40	1.21	1.11	1.05	10.0	1.30	1.20	1.15
1220.0	1.41	1.76	2.43	1.30	1.27	1.24	25.0	1.31	1.22	1.17
1320.0	1.36	1.76	2.43	1.48	1.49	1.51	55.0	1.36	1.27	1.22
1420.0	1.33	1.77	2.37	1.64	1.67	1.70	63.3	1.38	1.28	1.23
1520.0	1.35	1.75	2.32	1.53	1.62	1.74	126.4	1.43	1.36	1.33
1620.0	1.30	1.73	2.23	1.53	1.55	1.64	189.6	1.53	1.48	1.46
1720.0	1.23	1.81	2.40	1.55	1.51	1.52	252.7	1.61	1.59	1.57
1800.0	1.24	1.84	2.49	1.46	1.42	1.42	315.9	1.74	1.71	1.70
1820.0	1.28	1.87	2.61	1.40	1.38	1.39	379.0	1.80	1.78	1.77
1920.0	1.41	1.96	2.76	1.44	1.38	1.32	442.2	1.84	1.85	1.87
2020.0	1.62	2.10	2.92	2.08	1.99	1.92	505.3	1.84	1.88	1.92
2120.0	1.87	2.25	2.92	2.25	2.20	2.20	568.5	1.92	2.01	2.06
2170.0	1.97	2.20	2.88	2.40	2.40	2.40	631.6	2.06	2.18	2.25
2220.0	2.08	2.27	2.92	2.58	2.58	2.65	694.8	2.35	2.46	2.52
2320.0	2.46	2.49	2.92	3.16	3.26	3.26	757.9	2.72	2.88	2.92
2420.0	2.84	2.65	3.11	4.22	4.22	4.22	821.1	3.16	3.21	3.26

Typical Performance Curves

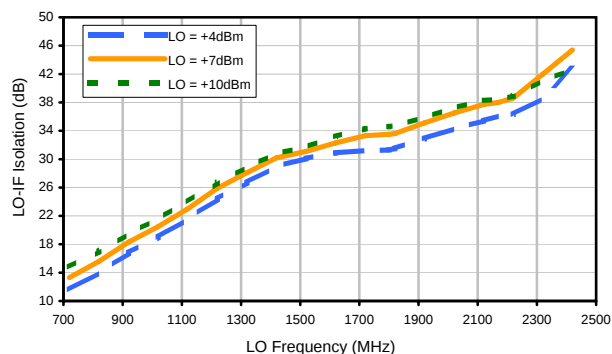
Conversion Loss



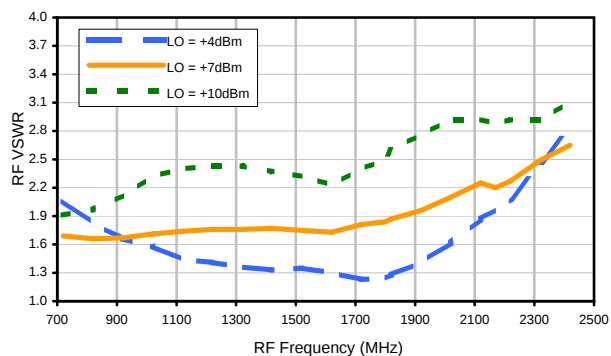
LO-RF Isolation



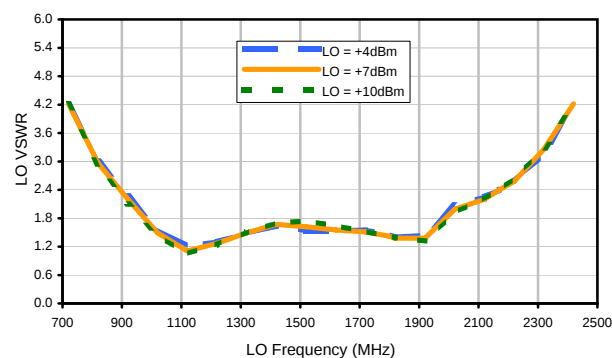
LO-IF Isolation



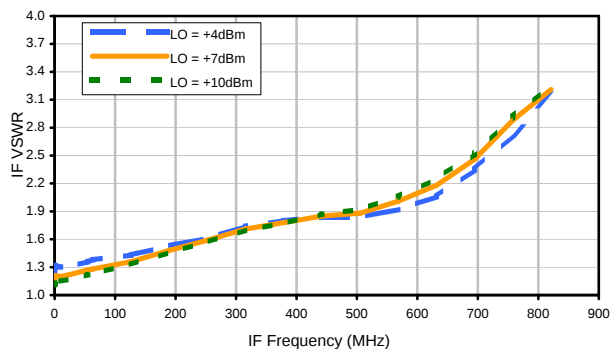
RF VSWR



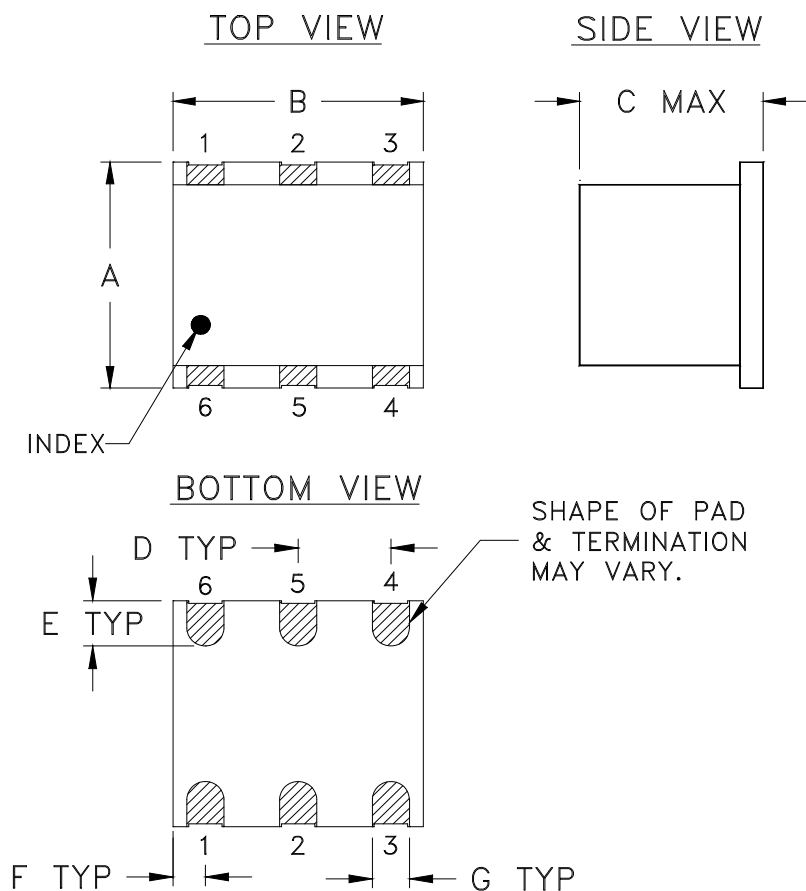
LO VSWR



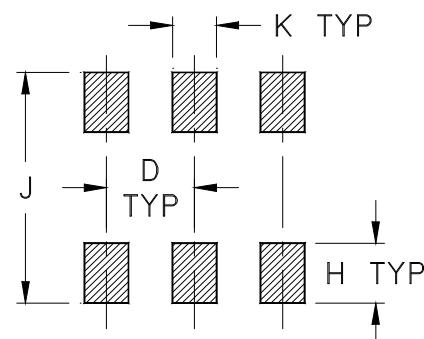
IF VSWR



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
TT240	.250 (6.35)	.31 (7.87)	.20 (5.08)	.100 (2.54)	.050 (1.27)	.055 (1.40)	.040 (1.02)	.070 (1.78)	.270 (6.86)	.050 (1.27)	.50

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Case material: Ceramic.
- Termination finish:
 - For RoHS Case Styles: 2-10 μ inch (.05-.25 microns) Gold plate over 100-300 μ inch (2.54-7.62 microns) Nickel plate. All models, (+) suffix.
 - For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



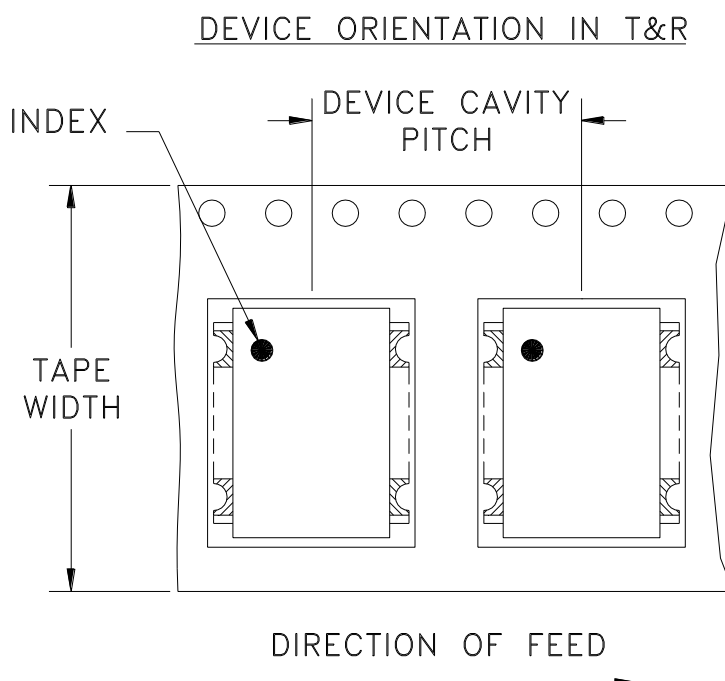
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The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F2



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel See note
16	12	7	10
			20
			50
			100
			200
		13	500

Note: Please consult individual model data sheet to determine device per reel availability

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



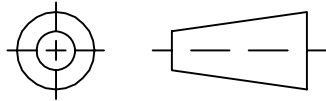
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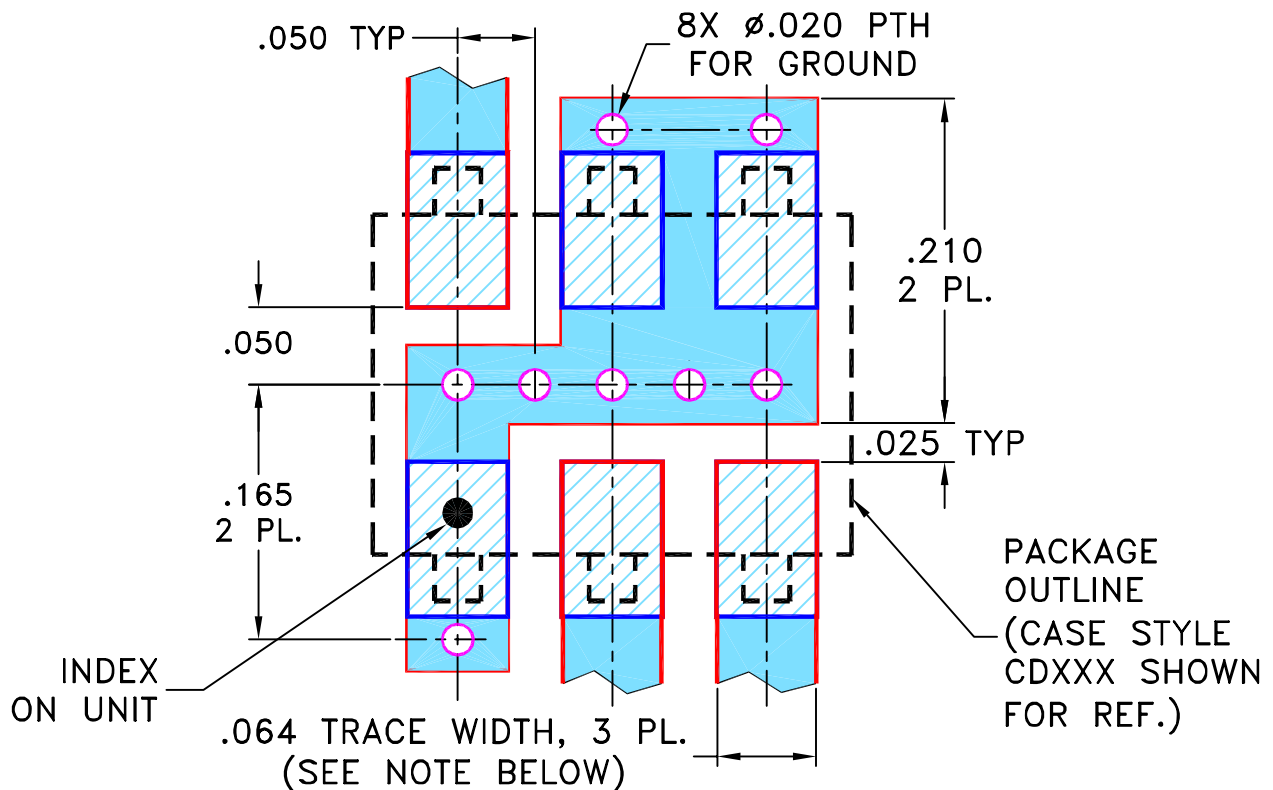
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
A	M101143	ADDED "gk" PIN CONNECTION, TT100 CASE STYLE & NOTE 2	10/10/05	MMG	DJ
B	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL
C	M108637	REMOVED "PIN 1", ADDED INDEX ON UNIT	12/01/06	MYG	FL

SUGGESTED MOUNTING CONFIGURATION
FOR BH292, CD541/542/636/637, TT100/240 CASE
STYLES, "gk", "ht", "hu", "nd", "w" PIN CONNECTIONS



- NOTES:** 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .030" $\pm$.002"; COPPER: 1/2 OZ. EACH SIDE.
 FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC
 (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

MMG

07/17/02

CHECKED

WL

08/02/02

APPROVED

DJ

08/05/02



Mini-Circuits®

13 Neptune Avenue
 Brooklyn NY 11235

PL, gk/ht/hu/nd/w, BH292,
 CD541/542/636/637, TT100/240, TB-03

SIZE

A

CODE IDENT

15542

DRAWING NO:

98-PL-052

REV:

C

FILE:

98PL052

SCALE:

8:1

SHEET:

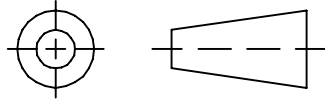
1 OF 1

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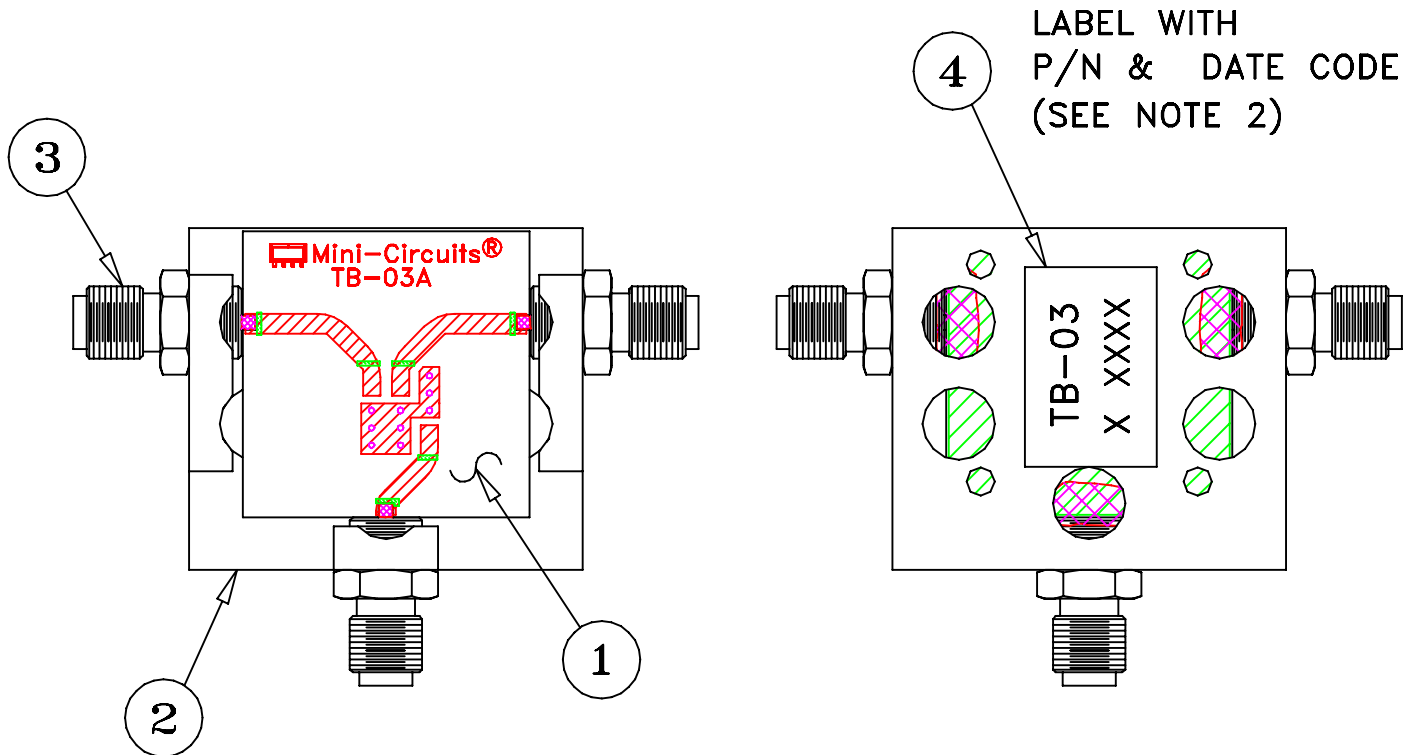
ASHEETA1.DWG REV:A DATE:01/12/95

THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
E	M119737	UPDATED PCB	10.08	MF	AD
F	M127659	UPDATED CARR	06.10	SW	SG
G	M127846	UPDATED SCHEMATIC DIAGRAM	06.10	SW	SG
H	M131840	UPDATED DWG	05.11	MF	AD

**NOTES:**

1. REFER TO -09 PAGE FOR ITEM DESCRIPTIONS.
DESIGNATION NUMBERS ON -20 PAGE CORRESPOND TO THE NUMBERS ON -09 PAGE.
2. FOR TEXT HEIGHT & STYLE ON THE LABEL REFER TO: D3-G209.

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

DRAWN

S.WOLYNSKI

08.29.99

TOLERANCES ON:

CHECKED

SG

07.06.99

2 PL DECIMALS ±

APPROVED

MG

07.10.99

3 PL DECIMALS ±

ANGLES ±

FRACTIONS ±

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Mini-Circuits® 13 Neptune Avenue
Brooklyn NY 11235

TB,ADE,CD542/636,06MX01,50

SIZE

A

CODE IDENT

15542

DRAWING NO:

TB-03-20

REV:

H

FILE:

WTB-03

SCALE:

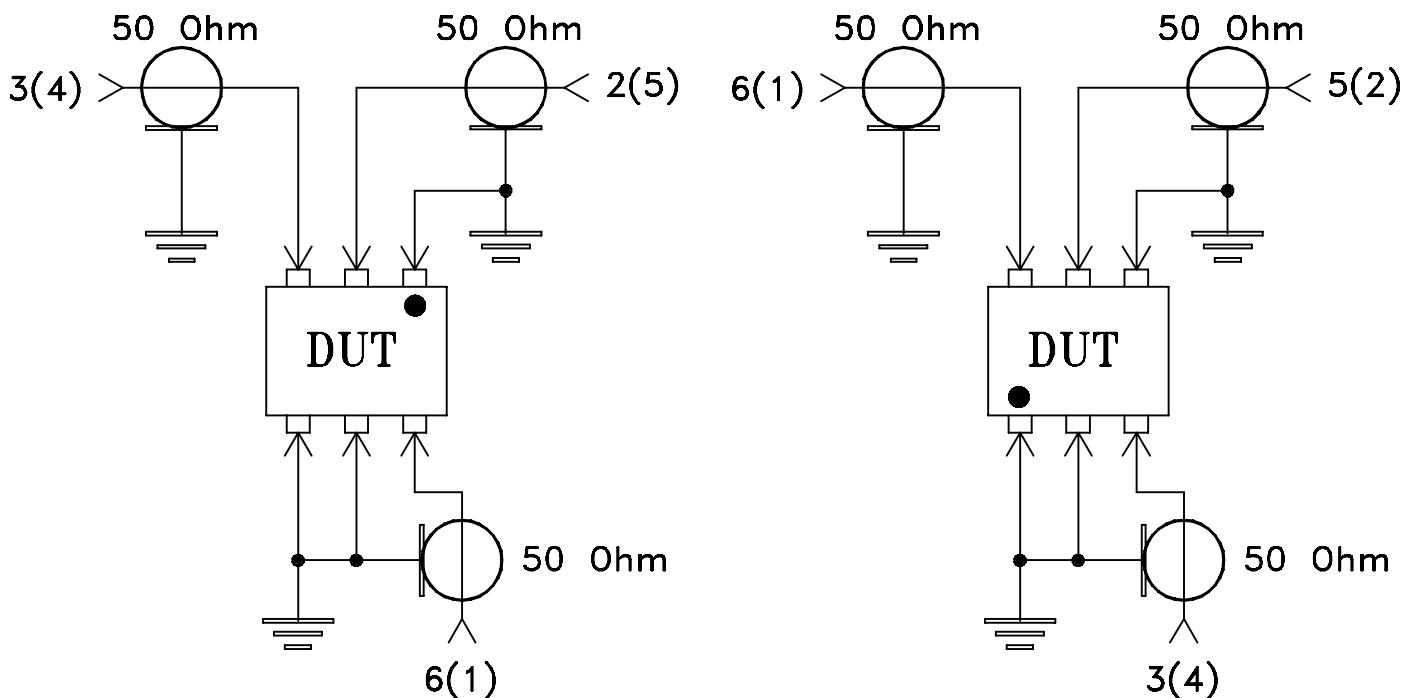
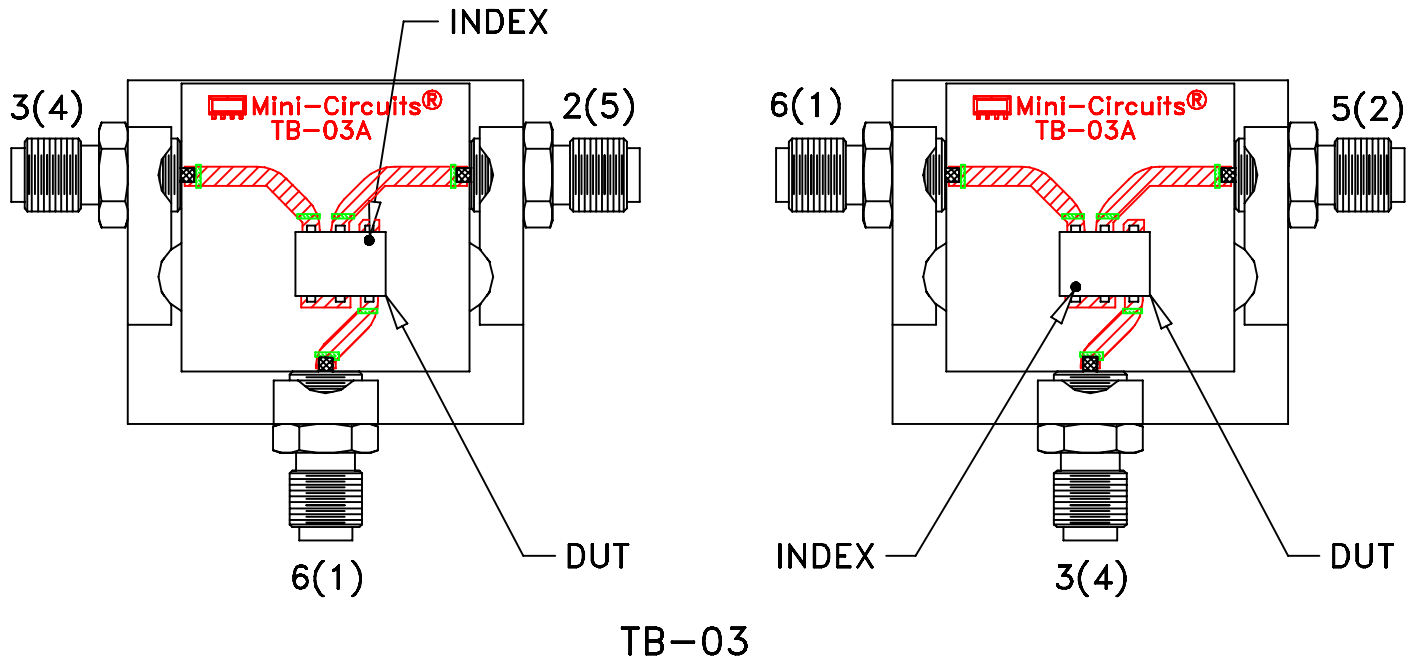
1.5:1

SHEET:

1 OF 2

Evaluation Board and Circuit

For Pin Connections and DUT Orientation Refer to
Data Sheet of the DUT



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

Mini-Circuits®



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215